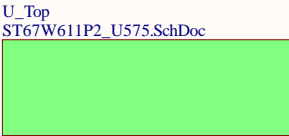


ST67W611M1A6P- RX diversity

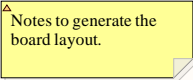
B2415

Table of contents

- Sheet 1: Project overview (this page)
- Sheet 2: ST67W611P2_U575



Legend

- General comment such as function title, configuration, ...
- Text to be added to silkscreen.
- Warning text.
-  Notes to generate the board layout.

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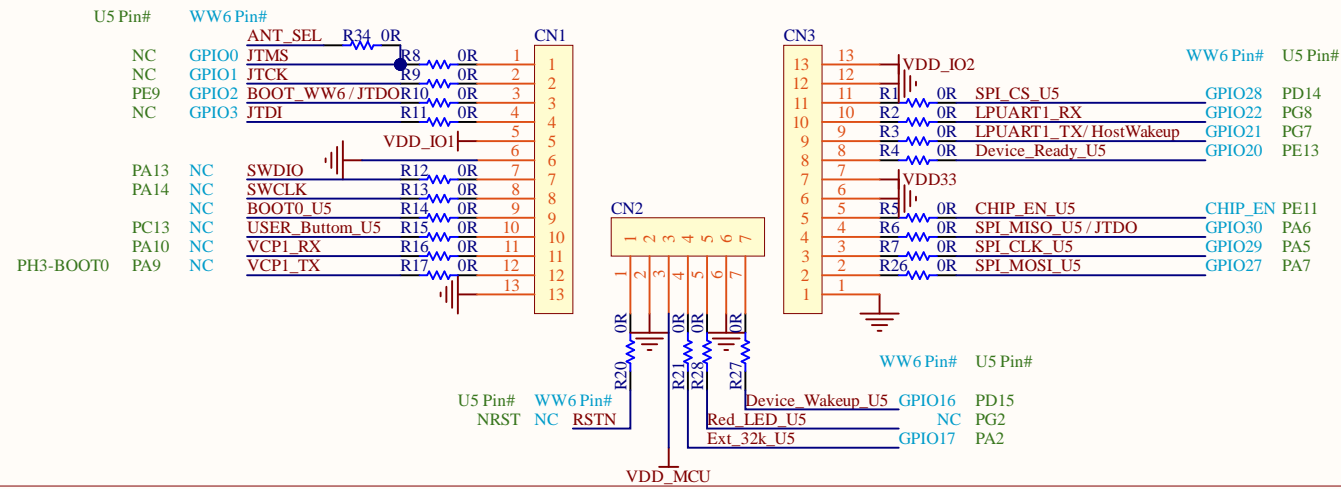
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Title: Project overview		
Project: ST67W611M1A6P- RX diversity		
Variant: [No Variations]		
Revision: A-01		Reference: B2415
Size: A4	Date: April-2025	Sheet: 1 of 7

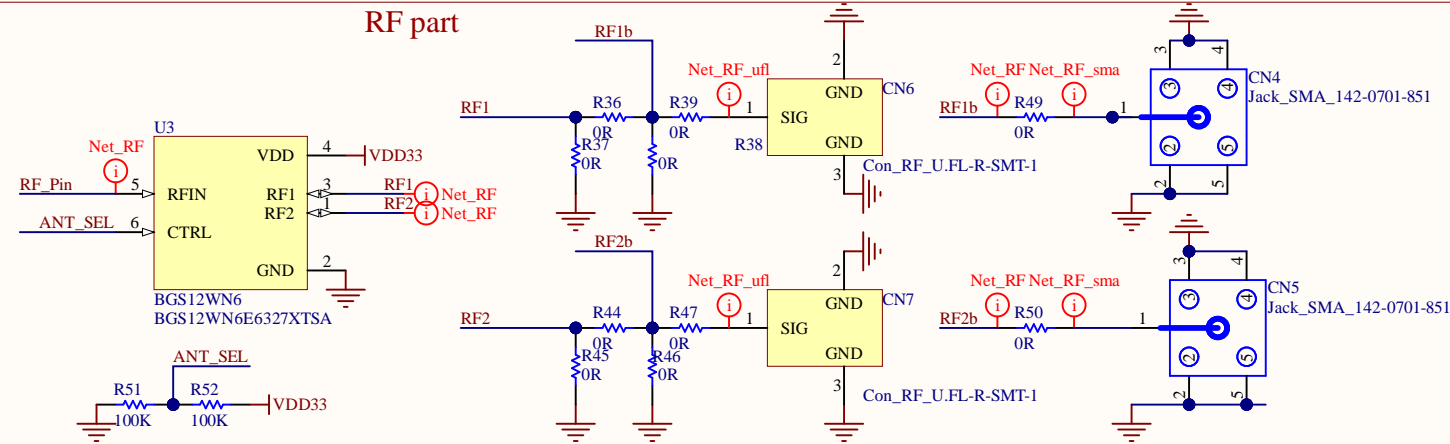


ST67W611M1A6-P with STM32U575AI6QU RX diversity Stamp Board

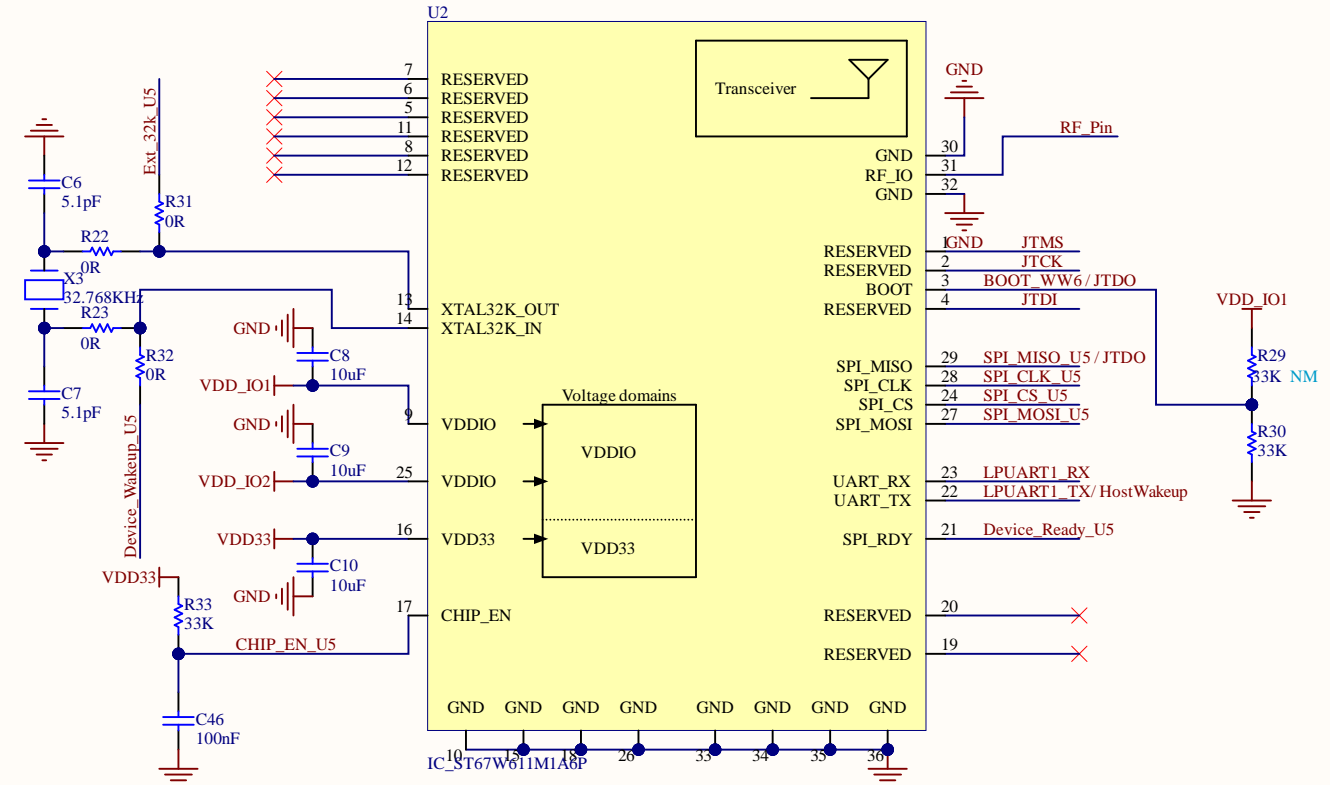
Stamp connectors

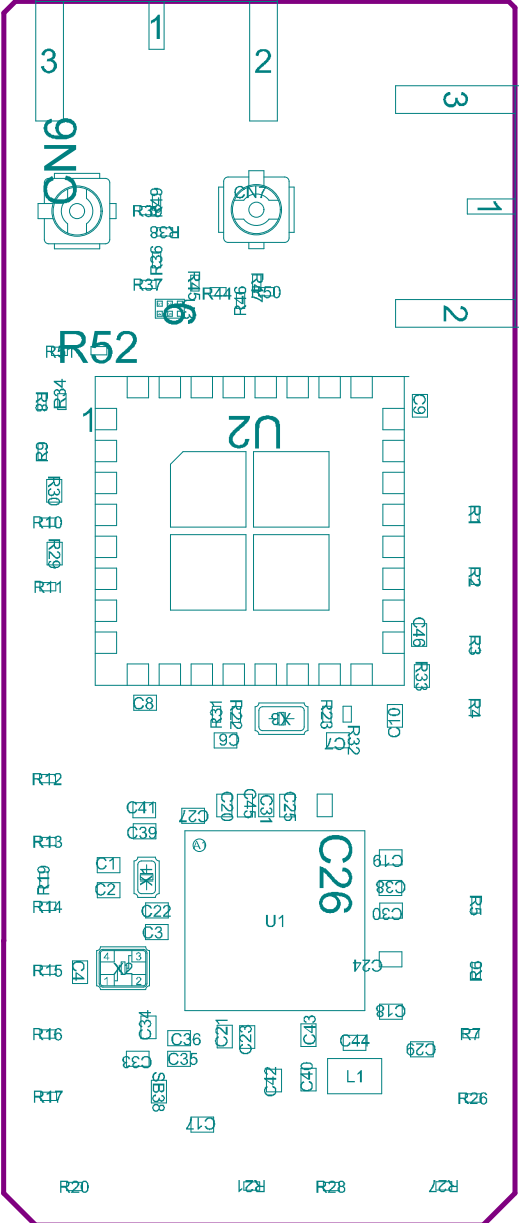


RF part




ST67W611 part

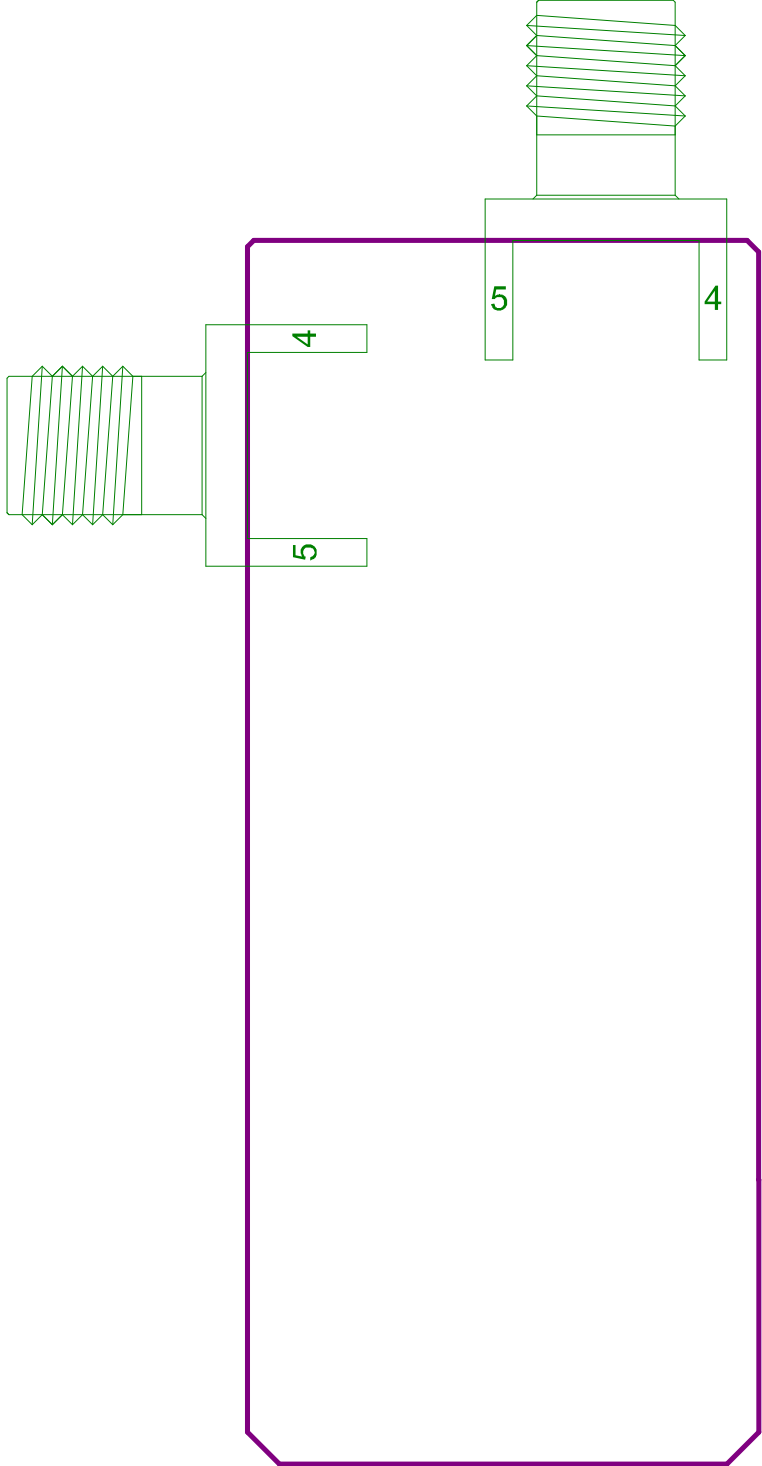


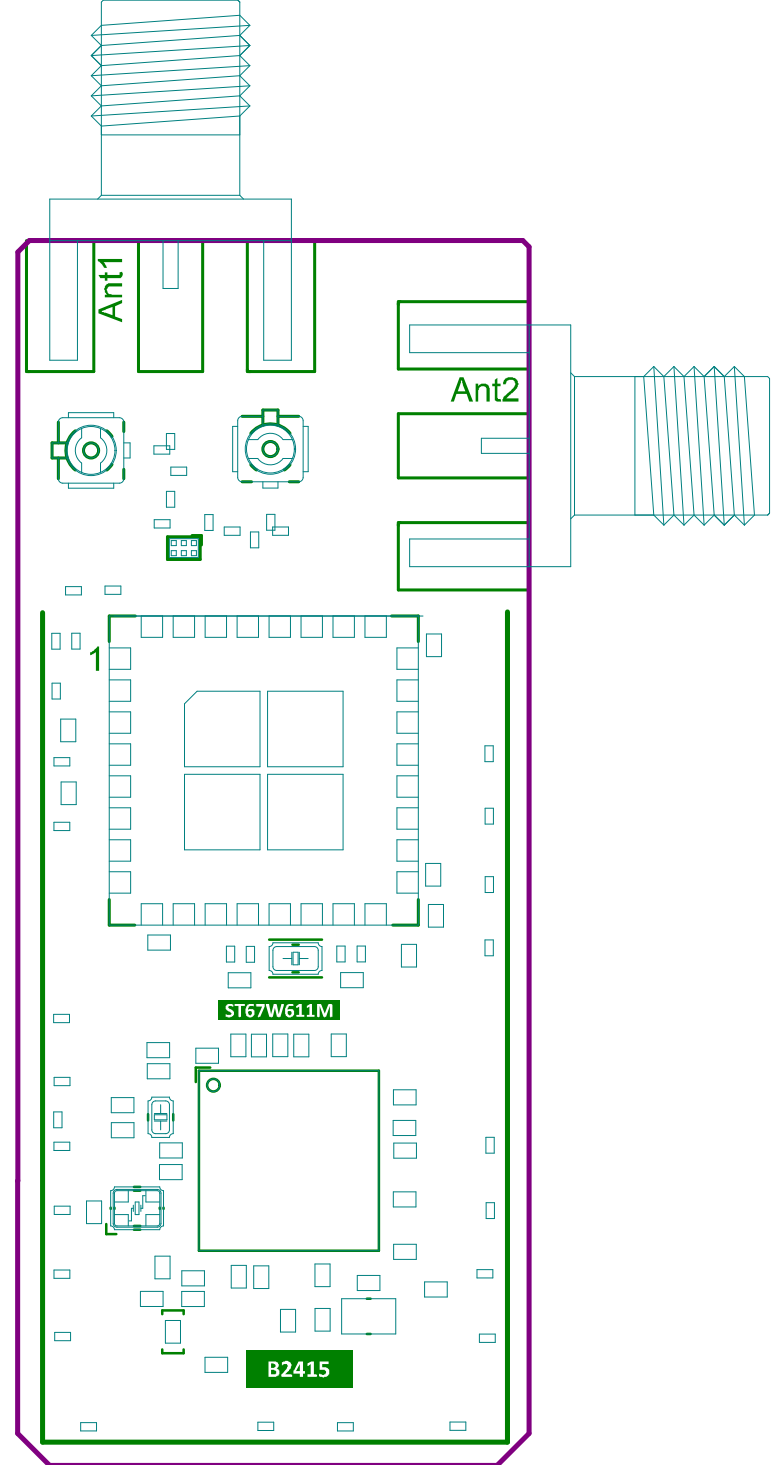


Project: ST67W611M1A6P- RX diversity	
Layer: M14-Top Assembly	Gerber: .GM14
Variant: [No Variations]	Ref: B2415
Date: April-2025	Rev: A



Project: ST67W611M1A6P- RX diversity		
Layer: M15-Bottom Assembly	Gerber:.GM15	
Variant: [No Variations]	Ref: B2415	
Date: April-2025	Rev: A	





Top Overlay

.GTO

Bottom Overlay

.GBO

